



# Product Change Notification

**Change Notification #:** 119254-00

**Change Title:** Select Intel® Compute Module HNS2600BPQR, Single, PCN 119254-00, Product Material, Air Duct Manufacturer and tooling changes

**Date of Publication:** September 01, 2022

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	September 16, 2022
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is changing the manufacturer and tooling of the air duct for the Intel® Compute Module listed in the Products Affected table.

Due to this change the air duct IPN will change from H95172-001 to H95172-002 which results in a TA roll up.

There are no expected changes in function, size or form.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Compute Module HNS2600BPQR, Single	HNS2600BPQR	985900	K36258-005	K36258-006

## PCN Revision History:

<b>Date of Revision:</b> September 01, 2022	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

**Americas Contact:** [asm0.pcn@intel.com](mailto:asm0.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

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